

IN THE PROPED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Koning et al.

Examiner:

Michael Aboagye

Serial No.:

10/747,927

Group Art Unit:

1725

Filed:

December 30, 2003

Docket:

884.863US1

Title:

NANOTUBE MODIFIED SOLDER THERMAL INTERMEDIATE

STRUCTURE, SYSTEMS, AND METHODS

Assignee:

Intel Corporation

Customer Number: 21186

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(b), it is believed that no fee or statement is required with the Supplemental Information Disclosure Statement.

Customer No.: 21186 Serial No :10/747,927

Filing Date: December 30, 2003

Title: NANOTUBE MODIFIED SOLDER THERMAL INTERMEDIATE STRUCTURE, SYSTEMS, AND METHODS

Assignee: Intel Corporation

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's below-signed representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

Respectfully submitted,

PAUL A. KONING ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. Attorneys for Intel Corporation

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Date Shenth 18, 45

Charles E. Steffey Reg. No. 25,179

<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 19th day of December, 2005.

Name

Signature

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Paul A. Koning et al.

Examiner: Michael Aboagye

Serial No.:

10/747,927

Group Art Unit: 1725

Filed:

December 30, 2003

Docket: 884.863US1

Title:

NANOTUBE MODIFIED SOLDER THERMAL INTERMEDIATE

STRUCTURE, SYSTEMS, AND METHODS

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

Serial/Patent No	 Filing Date/Issue D 	ate Attorney D	<u>ocket Title</u>
10/170313	June 12, 2002	884.564US1	INCREASING THERMAL
6891724			CONDUCTIVITY OF THERMAL
			INTERFACE USING CARBON
			NANOTUBES AND CVD
10/024057	December 17, 2001	884.569US1	METHOD AND APPARATUS
6921462			FOR PRODUCING ALIGNED
			CARBON NANOTUBE
			THERMAL INTERFACE
			STRUCTURE
10/738637	December 16, 2003	884.564US2	INCREASING THERMAL
			CONDUCTIVITY OF THERMAL
			INTERFACE USING CARBON
			NANOTUBES AND CVD

Page 2 Dkt: 884.863US1

COMMUNICATION CONCERNING RELATED APPLICATIONS

Serial Number: 10/747,927

Filing Date: December 30, 2003

Title: NANOTUBE MODIFIED SOLDER THERMAL INTERMEDIATE STRUCTURE, SYSTEMS, AND METHODS

11/104354

April 12, 2005

884.569US2

METHOD AND APPARATUS FOR PRODUCING ALIGNED CARBON NANOTUBE THERMAL INTERFACE STRUCTURE

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

PAUL A. KONING ET AL.

By Applicants' Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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By

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<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this <u>19th</u> day of December, 2005.

Name

Signature

PTO/SB/084(10-01)
Approved for use through 10/31/202. OMB 65-10-031
US Pleaset & Trademash Office. U.S. DEPARTMENT OF CAMBERCE
or the Papperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMS control number. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE 10/747,927 **Application Number** STATEMENT BY APPLICANT December 30, 2003 (Use as many sheets as necessary) **Filing Date** Koning, Paul **First Named Inventor** 1725 **Group Art Unit** DEC 2 7 2005 **Examiner Name** Aboagye, Michael TA TRADEME Attorney Docket No: 884.863US1 Sheet 1 of 1

US PATENT DOCUMENTS					
Examiner Initial *	USP Document Number Publication Date		Name of Patentee or Applicant of cited Document	Filing Date If Appropriate	
	US-5,102,824	04/07/1992	Neugebauer, C. F., et al.	11/05/1990	
	US-5,972,265	10/26/1999	Marra, A. A., et al.	05/21/1998	
	US-6,891,724	05/10/2005	De Lorenzo, D. S., et al.	06/12/2002	
	US-6,921,462	07/26/2005	Montgomery, S. W., et al.	12/17/2001	